

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
30V	2.2mΩ@10V	105A
	3.6mΩ@4.5V	

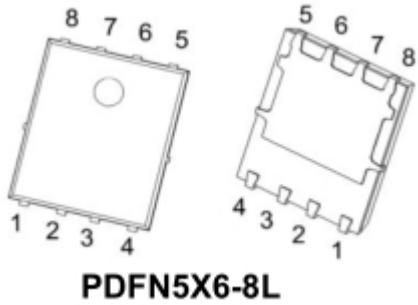
## Feature

- Advanced Trench Technology
- Provide Excellent RDS(ON) and Low Gate Charge

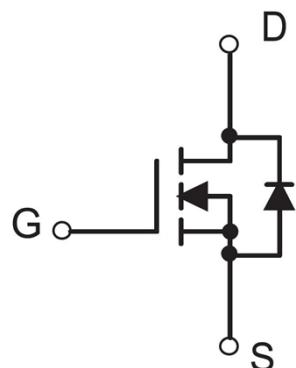
## Application

- Load Switch
- PWM Application

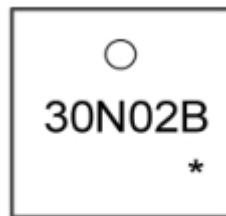
## Package



## Circuit diagram



## Marking



30N02B : Product code  
\* : Month code.

## Absolute maximum ratings

( $T_a = 25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current ( $T_c = 25^\circ\text{C}$ )	$I_D$	105	A
Pulsed Drain Current note <sup>1</sup>	$I_{DM}$	420	A
Single Pulsed Avalanche Energy note <sup>2</sup>	$E_{AS}$	350	mJ
Power Dissipation ( $T_c = 25^\circ\text{C}$ )	$P_D$	105	W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.19	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	$T_{STG}, T_J$	-55 to 150	$^\circ\text{C}$



ZL MOSFET

ZL30N02B

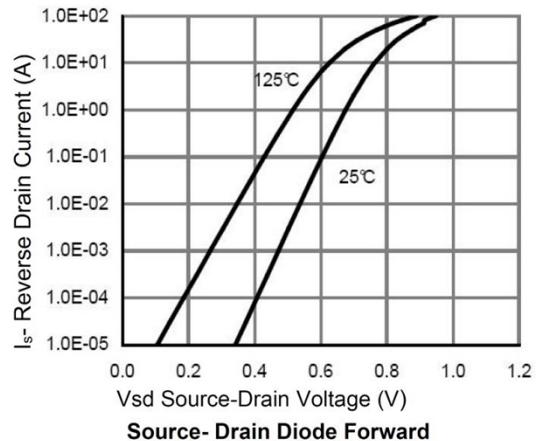
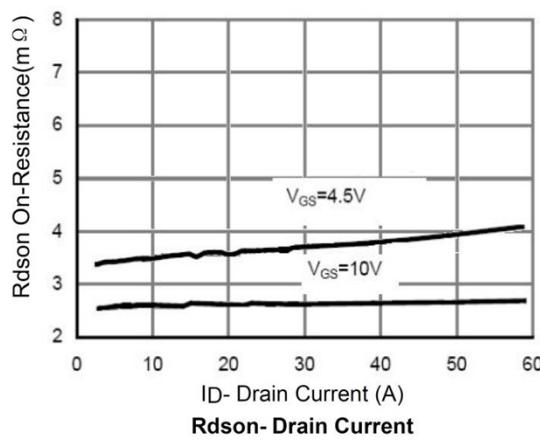
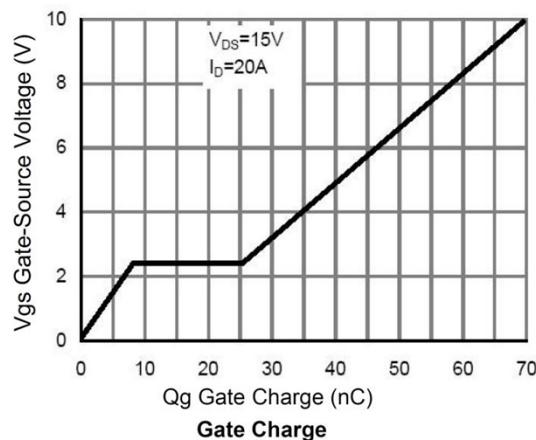
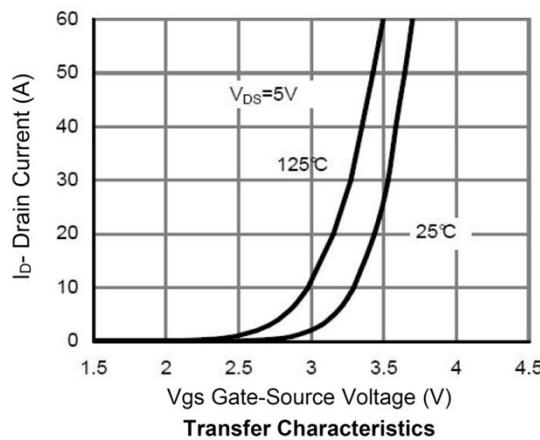
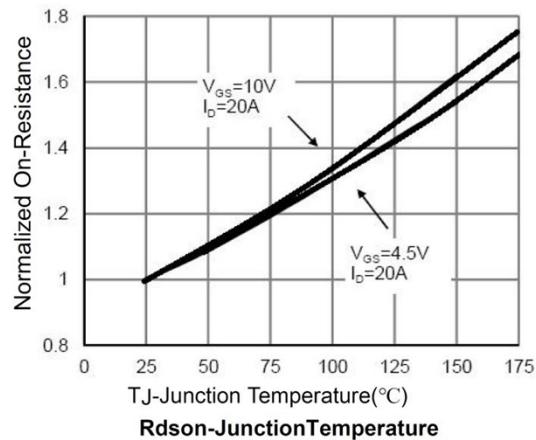
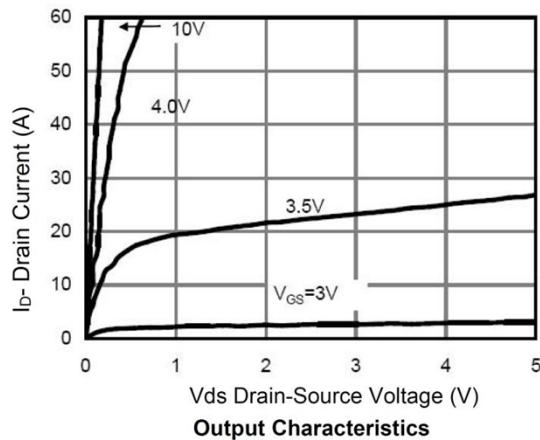
## Electrical characteristics

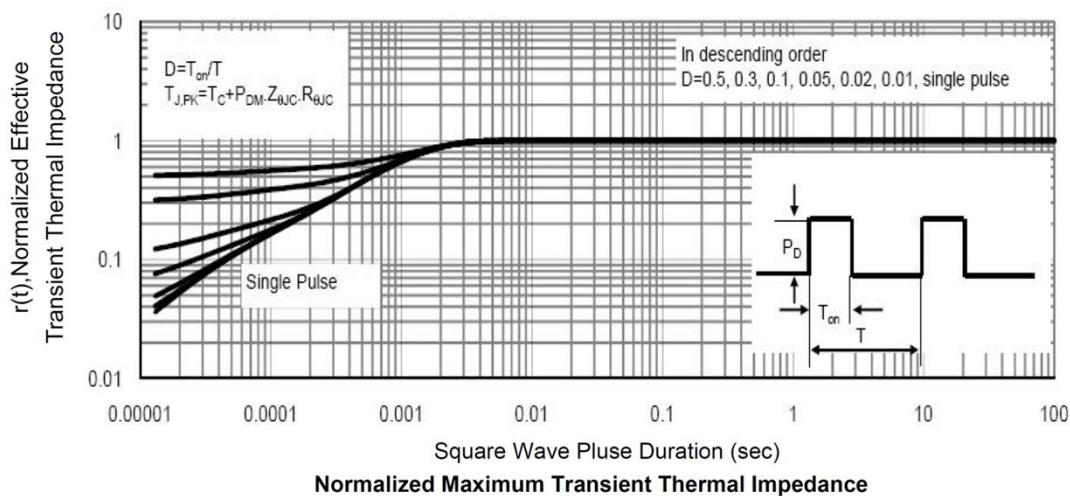
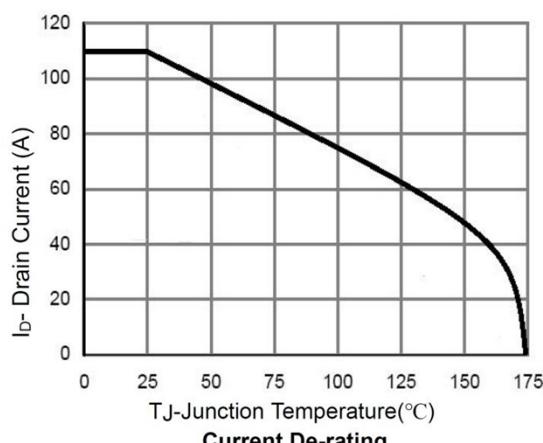
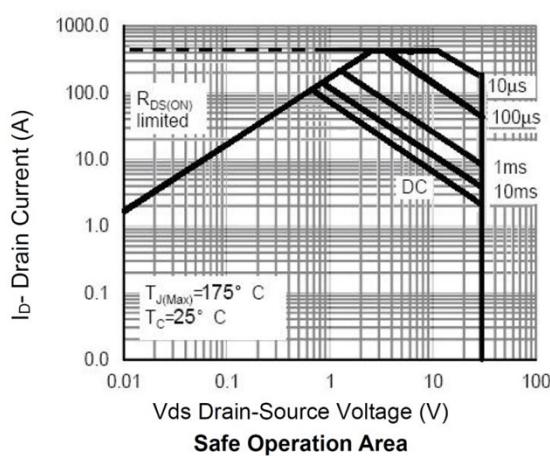
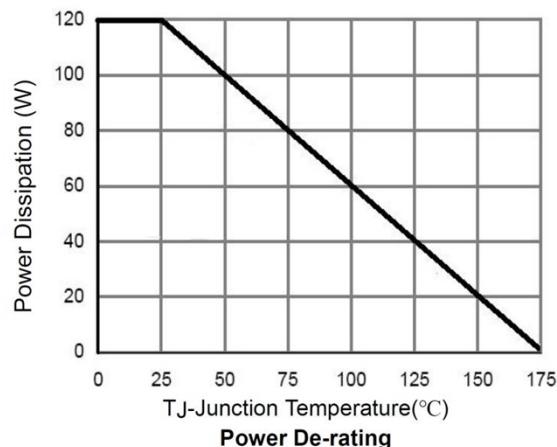
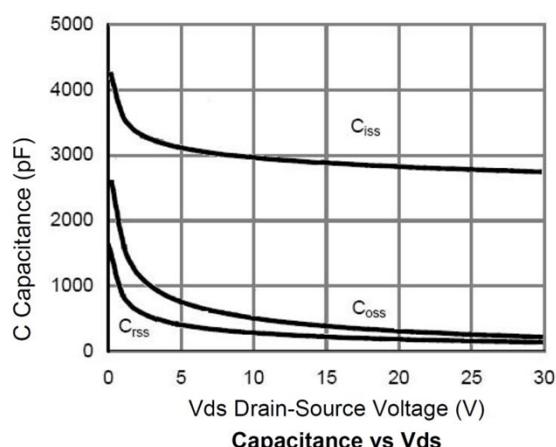
(T<sub>A</sub>=25°C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	BV <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	30			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V			1	μA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±100	μA
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	1	1.7	2.5	V
Static Drain-Source on-Resistance note3	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 30A		2.2	2.8	mΩ
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 20A		3.6	4.8	
<b>Dynamic Characteristics</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1MHz		3100		pF
Output Capacitance	C <sub>oss</sub>			456		
Reverse Transfer Capacitance	C <sub>rss</sub>			388		
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = 15V, I <sub>D</sub> = 30A, V <sub>GS</sub> = 10V		75		pF
Gate-Source Charge	Q <sub>gs</sub>			12		
Gate-Drain Charge	Q <sub>gd</sub>			18.3		
<b>Switching Characteristics</b>						
Turn-On Delay Time	T <sub>d(on)</sub>	V <sub>DD</sub> = 15V, I <sub>D</sub> = 60A, R <sub>GEN</sub> = 1.8Ω, V <sub>GS</sub> = 4.5V		11		nS
Rise Time	T <sub>r</sub>			120		
Turn-Off Delay Time	T <sub>d(off)</sub>			25		
Fall Time	T <sub>f</sub>			60		
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Maximum Continuous Drain to Source Diode Forward Current	I <sub>s</sub>				130	A
Maximum Pulsed Drain to Source Diode Forward Current	I <sub>SM</sub>				360	A
Drain to Source Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>s</sub> = 20A			1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 60A, dI/dt = 100A/μs		56		ns
Body Diode Reverse Recovery Time Charge	Q <sub>rr</sub>			110		nC

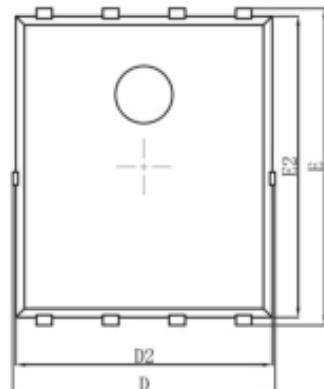
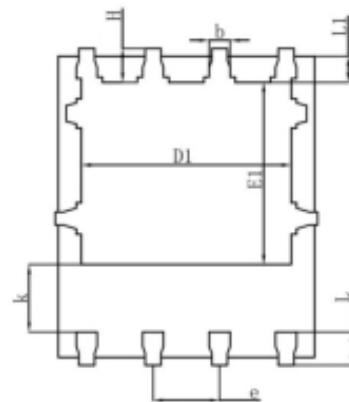
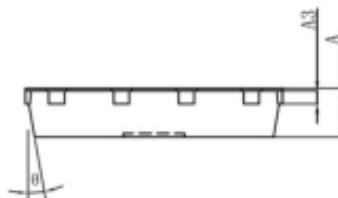
**Note:**1. E<sub>AS</sub> condition: T<sub>j</sub>=25°C, V<sub>G</sub>=10V, L=0.5mH, R<sub>g</sub>=25Ω

## Typical Characteristics





## PDFN5X6-8L Package Information


Top View  
 [顶视图]

Bottom View  
 [背视图]

Side View  
 [侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°